

## 1A High-Speed MOSFET Drivers

### Features

- Latch-Up Protected: Withstands 500 mA Reverse Current
- Input Withstands Negative Inputs Up to 5V
- Electrostatic Discharge (ESD) Protected: 2.0 kV (HBM) and 400V (MM)
- High Peak Output Current: 1A
- Wide Input Supply Voltage Operating Range:
  - 4.5V to 16V
- High Capacitive Load Drive Capability:
  - 1000 pF in 25 ns
- Short Delay Time: 30 ns typical
- Matched Delay Times
- Low Supply Current
  - With Logic '1' Input: 500  $\mu$ A
  - With Logic '0' Input: 100  $\mu$ A
- Low Output Impedance: 8 $\Omega$
- Available in Space-Saving 8-pin MSOP Package
- Pinout – same as TC1410/TC1412/TC1413

### Applications

- Switch Mode Power Supplies
- Pulse Transformer Drive
- Line Drivers
- Relay Driver

### General Description

The TC1411/TC1411N are 1A CMOS buffers/drivers. They do not latch up under any conditions within their power and voltage ratings. They are not subject to damage when up to 5V of noise spiking of either polarity occurs on the ground pin. They can accept, without damage or logic upset, up to 500 mA of current of either polarity being forced back into their output. All terminals are fully protected against Electrostatic Discharge (ESD) up to 2.0 kV (HBM) and 400V (MM).

As MOSFET drivers, the TC1411/TC1411N can easily charge a 1000 pF gate capacitance in 25 ns with matched rise and fall times. To ensure that the MOSFET's intended state is not affected even by large transients, low enough impedance in both the 'ON' and 'OFF' states are provided. The leading and trailing edge propagation delay times are also matched to allow driving short-duration inputs with greater accuracy.

### Package Types



# TC1411/TC1411N

## Functional Block Diagram



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings †

Supply Voltage .....	+20V
Input Voltage .....	$V_{DD} + 0.3V$ to GND – 5.0V
Power Dissipation ( $T_A \leq 70^\circ C$ )	
MSOP .....	340 mW
PDIP .....	730 mW
SOIC.....	470 mW
Storage Temperature Range .....	-65°C to +150°C
Maximum Junction Temperature .....	+150°C

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

### DC CHARACTERISTICS

**Electrical Specifications:** Unless otherwise noted, over the operating temperature range with  $4.5V \leq V_{DD} \leq 16V$ . Typical values are measured at  $T_A = +25^\circ C$ ,  $V_{DD} = 16V$ .

Parameters	Sym	Min	Typ	Max	Units	Conditions
<b>Input</b>						
Logic '1', High Input Voltage	$V_{IH}$	2.0	—	—	V	
Logic '0', Low Input Voltage	$V_{IL}$	—	—	0.8	V	
Input Current	$I_{IN}$	-1.0	—	1.0	$\mu A$	$0V \leq V_{IN} \leq V_{DD}$ , $T_A = +25^\circ C$
		-10	—	10		$-40^\circ C \leq T_A \leq +85^\circ C$
<b>Output</b>						
High Output Voltage	$V_{OH}$	$V_{DD} - 0.025$	—	—	V	DC Test
Low Output Voltage	$V_{OL}$	—	—	0.025	V	DC Test
Output Resistance	$R_O$	—	8	11	$\Omega$	$V_{DD} = 16V$ , $I_O = 10 mA$ , $T_A = +25^\circ C$
		—	10	14		$0^\circ C \leq T_A \leq +70^\circ C$
		—	10	14		$-40^\circ C \leq T_A \leq +85^\circ C$
Peak Output Current	$I_{PK}$	—	1.0	—	A	$V_{DD} = 16V$
Latch-Up Protection Withstand Reverse Current	$I_{REV}$	—	0.5	—	A	Duty cycle $\leq 2\%$ , $t \leq 300 \mu s$ , $V_{DD} = 16V$
<b>Switching Time (Note 1)</b>						
Rise Time	$t_R$	—	25	35	ns	$T_A = +25^\circ C$
		—	27	40		$0^\circ C \leq T_A \leq +70^\circ C$
		—	29	40		$-40^\circ C \leq T_A \leq +85^\circ C$ , <a href="#">Figure 4-1</a>
Fall Time	$t_F$	—	25	35	ns	$T_A = +25^\circ C$
		—	27	40		$0^\circ C \leq T_A \leq +70^\circ C$
		—	29	40		$-40^\circ C \leq T_A \leq +85^\circ C$ , <a href="#">Figure 4-1</a>
Delay Time	$t_{D1}$	—	30	40	ns	$T_A = +25^\circ C$
		—	33	45		$0^\circ C \leq T_A \leq +70^\circ C$
		—	35	45		$-40^\circ C \leq T_A \leq +85^\circ C$ , <a href="#">Figure 4-1</a>
Delay Time	$t_{D2}$	—	30	40	ns	$T_A = +25^\circ C$
		—	33	45		$0^\circ C \leq T_A \leq +70^\circ C$
		—	35	45		$-40^\circ C \leq T_A \leq +85^\circ C$ , <a href="#">Figure 4-1</a>

**Note 1:** Switching times ensured by design.

# TC1411/TC1411N

## DC CHARACTERISTICS (CONTINUED)

**Electrical Specifications:** Unless otherwise noted, over the operating temperature range with  $4.5V \leq V_{DD} \leq 16V$ . Typical values are measured at  $T_A = +25^\circ C$ ,  $V_{DD} = 16V$ .

Parameters	Sym	Min	Typ	Max	Units	Conditions
<b>Power Supply</b>						
Power Supply Current	$I_S$	—	0.5	1.0	mA	$V_{IN} = 3V, V_{DD} = 16V$
		—	0.1	0.15		$V_{IN} = 0V$

**Note 1:** Switching times ensured by design.

## TEMPERATURE CHARACTERISTICS

**Electrical Specifications:** Unless otherwise noted, all parameters apply with  $4.5V \leq V_{DD} \leq 16V$ .

Parameters	Sym	Min	Typ	Max	Units	Conditions
<b>Temperature Ranges</b>						
Specified Temperature Range (C)	$T_A$	0	—	+70	$^\circ C$	
Specified Temperature Range (E)	$T_A$	-40	—	+85	$^\circ C$	
Specified Temperature Range (V)	$T_A$	-40	—	+125	$^\circ C$	
Maximum Junction Temperature	$T_J$	—	—	+150	$^\circ C$	
Storage Temperature Range	$T_A$	-65	—	+150	$^\circ C$	
<b>Package Thermal Resistances</b>						
Thermal Resistance, 8L-MSOP	$\theta_{JA}$	—	211	—	$^\circ C/W$	
Thermal Resistance, 8L-PDIP	$\theta_{JA}$	—	89.3	—	$^\circ C/W$	
Thermal Resistance, 8L-SOIC	$\theta_{JA}$	—	149.5	—	$^\circ C/W$	

## 2.0 TYPICAL PERFORMANCE CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

**Note:** Unless otherwise indicated, over operating temperature range with  $4.5V \leq V_{DD} \leq 16V$ .



**FIGURE 2-1:** Quiescent Supply Current vs. Supply Voltage.



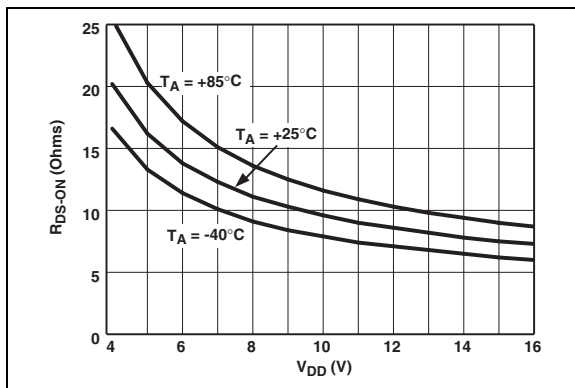
**FIGURE 2-4:** Quiescent Supply Current vs. Temperature.



**FIGURE 2-2:** Input Threshold vs. Supply Voltage.



**FIGURE 2-5:** Input Threshold vs. Temperature.



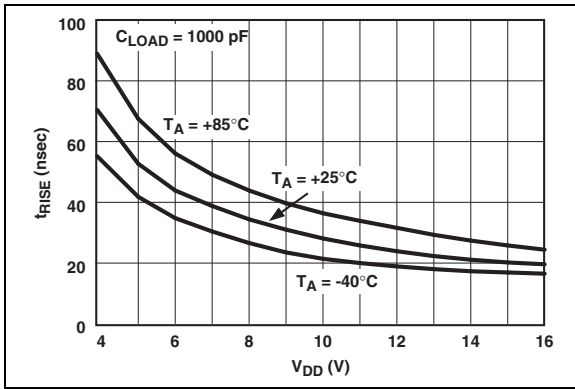
**FIGURE 2-3:** High-State Output Resistance vs. Supply Voltage.



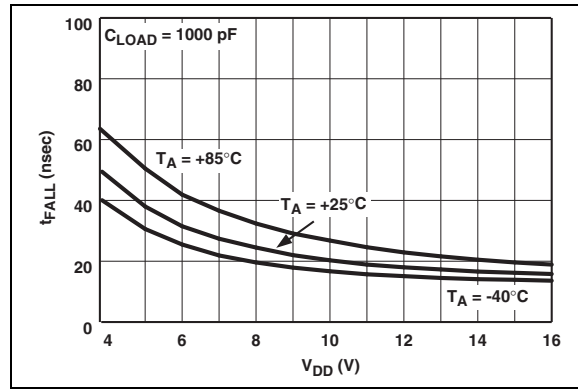
**FIGURE 2-6:** Low-State Output Resistance vs. Supply Voltage.

# TC1411/TC1411N

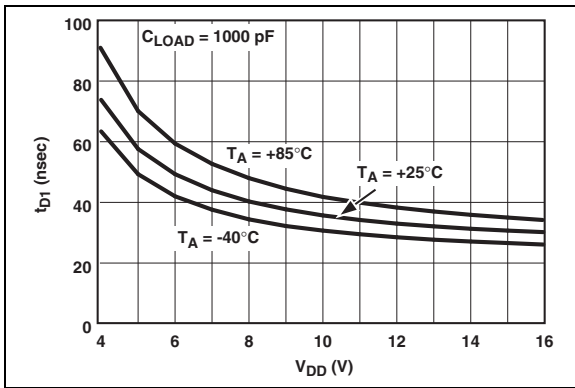
**Note:** Unless otherwise indicated, over operating temperature range with  $4.5V \leq V_{DD} \leq 16V$ .



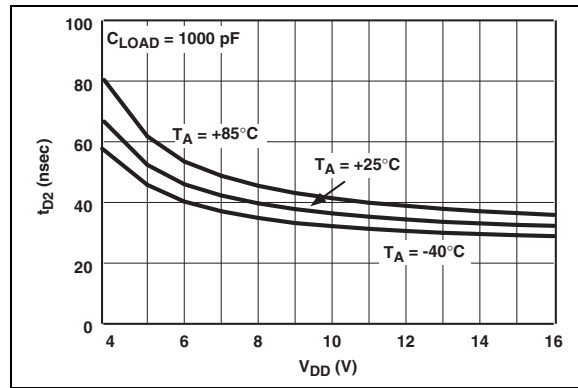
**FIGURE 2-7:** Rise Time vs. Supply Voltage.



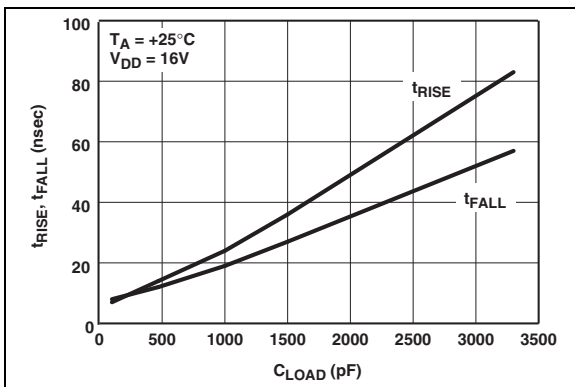
**FIGURE 2-10:** Fall Time vs. Supply Voltage.



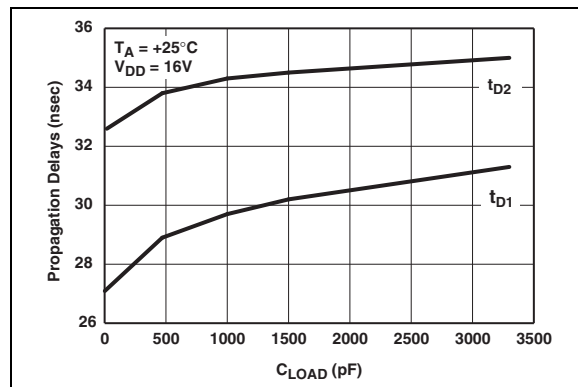
**FIGURE 2-8:** Propagation Delay vs. Supply Voltage.



**FIGURE 2-11:** Propagation Delay vs. Supply Voltage.



**FIGURE 2-9:** Rise and Fall Times vs. Capacitive Load.



**FIGURE 2-12:** Propagation Delays vs. Capacitive Load.

## 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in [Table 3-1](#).

**TABLE 3-1: PIN FUNCTION TABLE**

Pin No.	TC1411 MSOP, PDIP, SOIC	TC1411N MSOP, PDIP, SOIC	Description
1	V <sub>DD</sub>	V <sub>DD</sub>	Supply input, 4.5V to 16V
2	IN	IN	Control input
3	NC	NC	No connection
4	GND	GND	Ground
5	GND	GND	Ground
6	$\overline{\text{OUT}}$	OUT	CMOS push-pull output, common to pin 7
7	$\overline{\text{OUT}}$	OUT	CMOS push-pull output, common to pin 6
8	V <sub>DD</sub>	V <sub>DD</sub>	Supply input, 4.5V to 16V

### 3.1 Supply Input (V<sub>DD</sub>)

The V<sub>DD</sub> input is the bias supply for the MOSFET driver and is rated for 4.5V to 16V with respect to the ground pin. The V<sub>DD</sub> input should be bypassed to ground with a local ceramic capacitor. The value of the capacitor is chosen based on the capacitive load that is being driven. A value of 1.0  $\mu$ F is suggested.

### 3.2 Control Input (IN)

The MOSFET driver input is a high-impedance, TTL/CMOS-compatible input. The input has 300 mV of hysteresis between the high and low thresholds that prevents output glitching even when the rise and fall time of the input signal is very slow.

### 3.3 CMOS Push-pull Output (OUT, $\overline{\text{OUT}}$ )

The MOSFET driver output is a low impedance, CMOS push-pull style output, capable of driving a capacitive load with 1A peak currents.

### 3.4 Ground (GND)

The ground pins are the return path for the bias current and for the high peak currents which discharge the load capacitor. The ground pins should be tied into a ground plane or have very short traces to the bias supply source return.

### 3.5 No Connect (NC)

No internal connection.

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## 4.0 APPLICATION INFORMATION



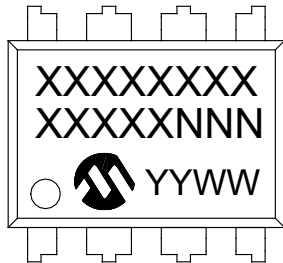
**FIGURE 4-1:** Switching Time Test Circuit.



## 5.0 PACKAGING INFORMATION

### 5.1 Package Marking Information

8-Lead PDIP (300 mil)



Example



OR



<b>Legend:</b>	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	RoHS Compliant JEDEC designator for Matte Tin (Sn)
	*	This package is RoHS Compliant. The RoHS Compliant JEDEC designator ((e3)) can be found on the outer packaging for this package.

**Note:** In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

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8-Lead SOIC (3.90 mm)



Example



OR



8-Lead MSOP (3x3 mm)



Example



## 8-Lead Plastic Micro Small Outline Package (UA) [MSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing C04-111C Sheet 1 of 2

# TC1411/TC1411N

## 8-Lead Plastic Micro Small Outline Package (UA) [MSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Number of Pins	N		8	
Pitch	e	0.65 BSC		
Overall Height	A	-	-	1.10
Molded Package Thickness	A2	0.75	0.85	0.95
Standoff	A1	0.00	-	0.15
Overall Width	E	4.90 BSC		
Molded Package Width	E1	3.00 BSC		
Overall Length	D	3.00 BSC		
Foot Length	L	0.40	0.60	0.80
Footprint	L1	0.95 REF		
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.08	-	0.23
Lead Width	b	0.22	-	0.40

**Notes:**

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.  
 BSC: Basic Dimension. Theoretically exact value shown without tolerances.  
 REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-111C Sheet 2 of 2

## 8-Lead Plastic Micro Small Outline Package (UA) [MSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Contact Pad Spacing	C		4.40	
Overall Width	Z			5.85
Contact Pad Width (X8)	X1			0.45
Contact Pad Length (X8)	Y1			1.45
Distance Between Pads	G1	2.95		
Distance Between Pads	GX	0.20		

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2111A

# TC1411/TC1411N

## 8-Lead Plastic Dual In-Line (PA) – 300 mil Body [PDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packageing>



Dimension Limits	Units	INCHES		
		MIN	NOM	MAX
Number of Pins	N	8		
Pitch	e	.100 BSC		
Top to Seating Plane	A	–	–	.210
Molded Package Thickness	A2	.115	.130	.195
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.290	.310	.325
Molded Package Width	E1	.240	.250	.280
Overall Length	D	.348	.365	.400
Tip to Seating Plane	L	.115	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.040	.060	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

**Notes:**

- Pin 1 visual index feature may vary, but must be located with the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M.  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-018B

## 8-Lead Plastic Small Outline (OA) - Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Microchip Technology Drawing No. C04-057C Sheet 1 of 2

# TC1411/TC1411N

## 8-Lead Plastic Small Outline (OA) - Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		Units	MILLIMETERS		
Dimension Limits			MIN	NOM	MAX
Number of Pins	N		8		
Pitch	e		1.27 BSC		
Overall Height	A	-	-	-	1.75
Molded Package Thickness	A2		1.25	-	-
Standoff §	A1		0.10	-	0.25
Overall Width	E		6.00 BSC		
Molded Package Width	E1		3.90 BSC		
Overall Length	D		4.90 BSC		
Chamfer (Optional)	h		0.25	-	0.50
Foot Length	L		0.40	-	1.27
Footprint	L1		1.04 REF		
Foot Angle	$\varphi$		0°	-	8°
Lead Thickness	c		0.17	-	0.25
Lead Width	b		0.31	-	0.51
Mold Draft Angle Top	$\alpha$		5°	-	15°
Mold Draft Angle Bottom	$\beta$		5°	-	15°

### Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
- Dimensioning and tolerancing per ASME Y14.5M  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.  
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-057C Sheet 2 of 2



## 8-Lead Plastic Small Outline (OA) – Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	1.27 BSC		
Contact Pad Spacing	C	5.40		
Contact Pad Width (X8)	X1			0.60
Contact Pad Length (X8)	Y1			1.55

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2057A

# TC1411/TC1411N

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## APPENDIX A: REVISION HISTORY

### Revision E (June 2013)

The following is the list of modifications:

- Updated the values for Electrostatic Discharge (ESD) in the [Features](#) and [General Description](#) columns.
- Updated the Pin Description table in [Section 3.0, Pin Descriptions](#).
- Updated package marking information and drawings in [Section 5.0, Packaging Information](#).
- Minor grammatical and spelling corrections.

### Revision D (September 2006)

- Added -40°C to +125°C temperature range to Temperature Characteristics table and Product Information System page.
- Added disclaimer to package outline drawings.

### Revision C (March 2003)

- Added 8-Lead MSOP Package.

### Revision B (May 2002)

- Converted TELCOM data sheet for Embedded Control Handbook

### Revision A (March 2001)

- Original Release of this Document.

# TC1411/TC1411N

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NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

<u>PART NO.</u>	<u>X</u>	<u>/XX</u>	<b>Examples:</b>
Device	Temperature Range	Package	
<p><b>Device:</b> TC1411: 1 A Single MOSFET Driver, Inverting TC1411N: 1 A Single MOSFET Driver, Non-Inverting</p> <p><b>Temperature Range:</b> C = 0°C to +70°C E = -40°C to +85°C V = -40°C to +125°C</p> <p><b>Package:</b> OA = Plastic SOIC, (150 mil Body), 8-lead OA713 = Plastic SOIC, (150 mil Body), 8-lead (Tape and Reel) UA = Plastic Micro Small Outline (MSOP), 8-lead * UA713 = Plastic Micro Small Outline (MSOP), 8-lead * (Tape and Reel) PA = Plastic DIP (300 mil Body), 8-lead * MSOP package is only available in E-Temp.</p>			<p>a) TC1411COA: 1A Single MOSFET driver, 8LD SOIC package, 0°C to +70°C.</p> <p>b) TC1411CPA: 1A Single MOSFET driver, 8LD PDIP package, 0°C to +70°C.</p> <p>c) TC1411EUA713: Tape and Reel, 1A Single MOSFET driver, 8LD MSOP package, -40°C to +85°C.</p> <p>d) TC1411VOA713: Tape and Reel, 1A Single MOSFET driver, 8LD SOIC package, -40°C to +125°C.</p>
			<p>a) TC1411NCPA: 1A Single MOSFET driver, 8LD PDIP package, 0°C to +70°C.</p> <p>b) TC1411NEPA: 1A Single MOSFET driver, 8LD PDIP package, -40°C to +85°C.</p> <p>c) TC1411NEUA: 1A Single MOSFET driver, 8LD MSOP package, -40°C to +85°C.</p> <p>d) TC1411NVPA: 1A Single MOSFET driver, 8LD PDIP package, -40°C to +125°C.</p>

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**Technical support is available through the web site at: <http://microchip.com/support>**

# TC1411/TC1411N

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NOTES:



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**Note the following details of the code protection feature on Microchip devices:**

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